



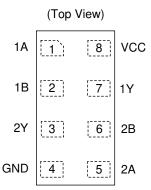
DUAL 2-INPUT NOR GATE

Description

The 74LVC2G02 is a dual, two input NOR gate. Both gates have push-pull outputs designed for operation over a power supply range of 1.65V to 5.5V. The device is fully specified for partial power down applications using $l_{\rm OFF}$. The $l_{\rm OFF}$ circuitry disables the output, preventing damaging current backflow when the device is powered down. Each gate performs the positive Boolean function:

$$Y = \overline{A + B}$$
 or $Y = \overline{A} \bullet \overline{B}$

Pin Assignments



X2-DFN2010-8 X2-DFN1410-8 X2-DFN1210-8

Features

- Wide Supply Voltage Range from 1.65 to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS Low Power Consumption
- I_{OFF} Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- Schmitt Trigger Action at all inputs makes the circuit tolerant for slower input rise and fall times. The hysteresis is typically 100mV at V_{CC} = 3.0V.
- ESD Protection Exceeds JESD 22
 - 2000-V Human Body Model (A114)
 - Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class I
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Applications

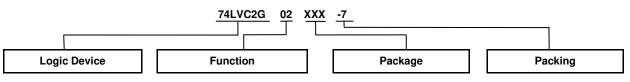
- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide Array of Products Such as:
 - PCs, Networking, Notebooks, Netbooks, PDAs
 - Tablet Computers, E-readers
 - Computer Peripherals, Hard Drives, CD/DVD ROMs
 - TVs, DVDs, DVRs, Set Top Boxes
 - Cell Phones, Personal Navigation / GPS
 - MP3 Players, Cameras, Video Recorders

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information (Note 4)



74 : Logic Prefix LVC: 1.65V to 5.5V Logic Family 2G: Dual Gate

02: 2-Input NOR Gate HD4: X2-DFN2010-8 HK3: X2-DFN1410-8 RA3: X2-DFN1210-8

-7: 7" Tape & Reel

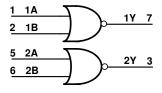
	Package	Package	Package	7" Tape and Reel (Note 6)		
Device	Code	(Note 5)	Size	Quantity	Part Number Suffix	
74LVC2G02HD4-7	HD4	X2-DFN2010-8	1.95mm x 1.0mm x 0.4mm 0.5 mm lead pitch	5,000/Tape & Reel	-7	
74LVC2G02HK3-7	HK3	X2-DFN1410-8	1.35mm x 1.0mm x 0.35mm 0.4 mm lead pitch	5,000/Tape & Reel	-7	
74LVC2G02RA3-7	RA3	X2-DFN1210-8	1.2mm x 1.0mm x 0.35mm 0.3 mm lead pitch	5,000/Tape & Reel	-7	

- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.
 The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf.

Pin Descriptions

Pin Name	Pin No.	Description
1A	1	Data Input
1B	2	Data Input
2Y	3	Data Output
GND	4	Ground
2A	5	Data Input
2B	6	Data Input
1Y	7	Data Output
V _{CC}	8	Supply Voltage

Logic Diagram



Function Table

Ir	Output	
Α	В	Υ
L	L	Н
L	Н	L
Н	L	L
Н	Н	L



Absolute Maximum Ratings (Notes 7 & 8)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
V _{CC}	Supply Voltage	-0.5 to +6.5	V
VI	Input Voltage	-0.5 to +6.5	V
Vo	Output Voltage -Active Mode	-0.5 to V _{CC} +0.5	V
VO	Output Voltage Power Down Mode	-0.5 to +6.5	V
I _{IK}	Input Clamp Current V _I <0	-50	mA
lok	Output Clamp Current (Vo < 0 OR Vo > Vcc)	±50	mA
lo	Continuous Output Current (Vo = 0 to V _{CC})	±50	mA
lcc	Continuous Current Through V _{CC}	100	mA
I _{GND}	Continuous Current Through GND	-100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Notes:

Recommended Operating Conditions (Note 9)

Symbol	Pa	Parameter			Unit
.,	On avating Maltage	Operating	1.65	5.5	V
Vcc	Operating Voltage	Data Retention Only	1.5	_	V
VI	Input Voltage		0	5.5	V
M	Output Voltage Active Mode		0	V _{CC}	V
V_{O}	Output Voltage Power-Down Mode		0	5.5	V
	I _{OH} High-Level Output Current	V _{CC} = 1.65V	_	-4	
		V _{CC} = 2.3V	_	-8	
		V _{CC} = 2.7V	_	-12	mA
I _{OH}	Tright-Level Output Current	V _{CC} = 3.0V	_	-16	
			_	-24	
		$V_{CC} = 4.5V$	_	-32	
		V _{CC} = 1.65V	_	4	
		V _{CC} = 2.3V	_	8	
I	Low-Level Output Current	V _{CC} = 2.7V	_	12	mA
l _{OL}	Low-Level Output Current	V 2.0V	_	16	IIIA
		$V_{CC} = 3.0V$	_	24	
		V _{CC} = 4.5V	_	32	
Δt/ΔV	Input Transition Bios or Fall Data	V _{CC} = 1.65V to 2.7V	_	20	20/1/
ΔυΔν	Input Transition Rise or Fall Rate	V _{CC} = 2.7V to 5.5V	_	10	ns/V
T _A	Operating Fi	ee-Air Temperature	-40	+125	°C

Note: 9. Unused inputs should be held at V_{CC} or Ground.

^{7.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device

 ^{7.} Stresses beyond the absolute maximum may result in infinediate failure of reduced reliability. These are stress values and device operation should be within recommend values.
 8. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.



Electrical Characteristics (All typical values are at T_A = +25°C)

O	Parameter Test Condition		v	-40	°C to +8	5°C	-40°C to	+125°C	
Symbol	Parameter	Test Conditions	V _{cc}	Min	Тур.	Max	Min	Max	Uni
			$V_{CC} = 1.65V \text{ to } 1.95V$	0.65 x V _{CC}	_	_	0.65 x V _{CC}	_	
	High-Level		V _{CC} = 2.3V to 2.7V	1.7	_	_	1.7	_	ĺ.,
V_{IH}	Input Voltage	_	V _{CC} = 2.7V to 3.6V	2.0	_	_	2.0	_	٧
			V _{CC} = 4.5V to 5.5V	0.7 x V _{CC}	_	_	0.7 x V _{CC}	_	
			$V_{CC} = 1.65V \text{ to } 1.95V$	_	_	0.35 x V _{CC}	_	0.35 x V _{CC}	
.,	Low-Level		V _{CC} = 2.3V to 2.7V	_	_	0.7	_	0.7	Ì.,
V_{IL}	Input Voltage	_	V _{CC} = 2.7V to 3.6V	_	_	0.8	_	0.8	V
			V _{CC} = 4.5V to 5.5V	_	_	0.3 x V _{CC}	_	0.3 x V _{CC}	
		I _{OH} = -100μA	1.65V to 5.5V	V _{CC} – 0.1	Vcc	_	V _{CC} – 0.1	_	
		I _{OH} = -4mA	1.65V	1.2	1.53	_	0.95	_	
	High-Level	I _{OH} = -8mA	2.3V	1.9	2.13	_	1.7	_	
V_{OH}	Output	I _{OH} = -12mA	2.7	2.2	2.5	_	1.9	_	V
	Voltage	I _{OH} = -16mA		2.4	2.7	_	2.2	_	
		I _{OH} = -24mA	3V	2.3	2.6	_	2.0	_	
		I _{OH} = -32mA	4.5V	3.8	4.1	_	3.4	_	
		I _{OL} = 100μA	1.65V to 5.5V	_	0	0.1	_	0.1	
		I _{OL} = 4mA	1.65V	_	0.08	0.45	_	0.7	
	Low-Level	I _{OL} = 8mA	2.3V	_	0.14	0.3	_	0.45	
V_{OL}	Output	I _{OL} = 12mA	2.7V	_	0.19	0.4	_	0.6	V
	Voltage	I _{OL} = 16mA		_	0.25	0.4	_	0.6	
		I _{OL} = 24mA	3V	_	0.37	0.55	_	0.8	
		I _{OL} = 32mA	4.5V	_	0.43	0.55	_	0.8	
II	Input Current	V _I = 5.5V or GND	0V to 5.5V	_	± 0.1	±5	_	± 20	μA
I _{OFF}	Power Down Leakage Current	V_1 or $V_0 = 5.5V$	0V	_	± 0.1	±10	_	±20	μA
I _{CC}	Supply Current	$V_1 = 5.5V$ or GND $I_0=0A$	1.65V to 5.5V	_	0.1	10	_	40	μA
ΔI _{CC}	Additional Supply Current	One input at V _{CC} – 0.6V Other inputs at V _{CC} or GND	2.3V to 5.5V	_	5	500	_	5,000	μ/
Cı	Input Capacitance	V _I = V _{CC} or GND	3.3V	_	2.5	_	_		pl



Operating Characteristics

Parameter		Test Conditions	V _{CC} = 1.8V Typ.	V _{CC} = 2.5V Typ.	V _{CC} = 3.3V Typ.	V _{CC} = 5V Typ.	Unit
C_pd	Power Dissipation Capacitance	f = 10MHz	18	18	19	22	pF

Package Characteristics

Symbol	Parameter	Package	Test Conditions	Min	Тур.	Max	Unit
	θ _{JA} Thermal Resistance Junction-to-Ambient	X2-DFN2010-8		-	313	-	
θ_{JA}		X2-DFN1410-8	(Note 10)	_	321	_	°C/W
		X2-DFN1210-8		_	395	_	
		X2-DFN2010-8		_	145	_	
θ_{JC}	Thermal Resistance Junction-	X2-DFN1410-8		_	166	_	°C/W
	to-Case	X2-DFN1210-8		-	236	_	

Note: 10. Test condition for each package type: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

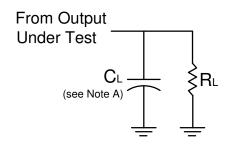
Switching Characteristics

Typical Values at $T_A = +25$ °C and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V. See Figure 1.

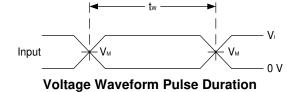
B	. From To		V	T _A	= -40°C to +85	5°C	T _A = -40°C	to +125°C	11
Parameter	Input	Output	Vcc	Min	Тур	Max	Min	Max	Unit
			1.8V ± 0.15V	1.2	3.8	8.9	1.2	11.2	
			2.5V ± 0.2V	0.8	2.4	5.4	0.8	6.8	
t _{pd}	A or B	Υ	2.7V	0.8	3.2	6.0	0.8	7.5	ns
			$3.3V \pm 0.3V$	0.6	2.4	4.9	0.6	6.2	
			5.0V ± 0.5V	0.6	1.8	4.3	0.6	5.5	

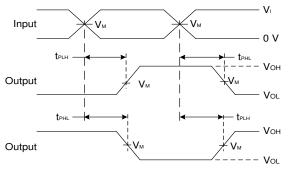


Parameter Measurement Information



V _{cc}	Inputs		. V _M	C ∟	R _L
V CC	Vı	t _r /t _f	• • • • • • • • • • • • • • • • • • •	5	ոլ
1.8V ± 0.15V	V _{CC}	≤2ns	V _{CC} /2	30pF	1kΩ
2.5V ± 0.2V	V _{CC}	≤2ns	V _{CC} /2	30pF	500Ω
2.7V	2.7V	≤2.5ns	1.5V	50pF	500Ω
$3.3V \pm 0.3V$	2.7V	≤2.5ns	1.5V	50pF	500Ω
5.0V ± 0.5V	V _{CC}	≤2.5ns	V _{CC} /2	50pF	500Ω





Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

A. Includes test lead and test apparatus capacitance.B. All pulses are supplied at pulse repetition rate ≤ 10MHz.

C. Inputs are measured separately one transition per measurement.

D. t_{PLH} and t_{PHL} are the same as $t_{\text{pd}}.$



Marking Information

(Top View)

<u>XX</u>

XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week

X : Internal Code

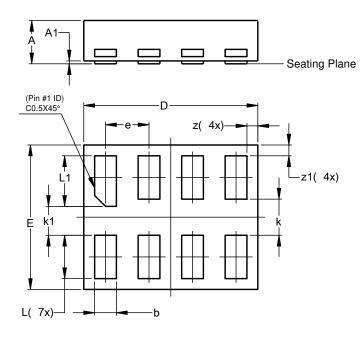
Part Number	Package	Identification Code
74LVC2G02HD4-7	X2-DFN2010-8	9B
74LVC2G02HK3-7	X2-DFN1410-8	9C
74LVC2G02RA3-7	X2-DFN1210-8	9D



X2-DFN1210-8 Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1210-8

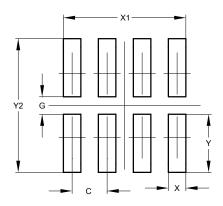


	X2-DFN	11210-8	
Dim	Min	Max	Тур
Α	-	0.35	0.30
A 1	0	0.03	0.02
b	0.10	0.20	0.15
D	1.15	1.25	1.20
Е	0.95	1.05	1.00
е	-	1	0.30
k	-	-	0.25
k1	-	-	0.20
L	0.25	0.35	0.30
L1	0.30	0.40	0.35
Z	0.050	0.100	0.075
z 1	0.050	0.100	0.075
All I	Dimens	ions in	mm

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1210-8



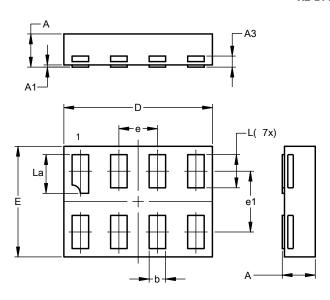
Dimensions	Value (in mm)
С	0.300
G	0.150
Х	0.150
X1	1.050
Y	0.500
Y1	1.150



X2-DFN1410-8 Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1410-8

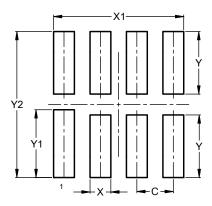


X2-DFN1410-8				
Dim	Min	Max	Тур	
Α	0.30	0.35	0.33	
A1	0.00	0.03	0.02	
А3			0.10	
b	0.12	0.20	0.15	
D	1.30	1.40	1.35	
E	0.95	1.05	1.00	
е			0.35	
e1			0.55	
L	0.27	0.35	0.30	
L1	0.32	0.40	0.35	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1410-8



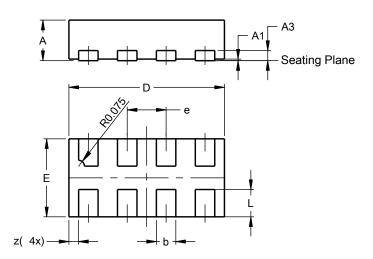
Dimensions	Value
Dillicipions	(in mm)
С	0.350
Х	0.200
X1	1.250
Υ	0.600
Y1	0.650
Y2	1.400



X2-DFN2010-8 Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN2010-8

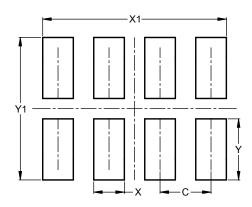


X2-DFN2010-8				
Dim	Min	Max	Тур	
Α		0.40		
A 1	0.00	0.05	0.02	
A3			0.13	
b	0.20	0.30	0.25	
D	1.950	2.05	2.00	
Е	0.95	1.05	1.00	
е			0.50	
L	0.30	0.40	0.35	
Z	-	-	0.125	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN2010-8



Dimensions	Value (in mm)
С	0.500
Х	0.300
X1	1.800
Υ	0.600
V1	1.400



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